



Material Content Data Sheet



Sales Product Name		IPAN70R900P7S		Issued		31. July 2018		
MA#		MA001821710						
Package		PG-TO220-3-318		Weight*		2127.00 mg		
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	1.203	0.06	0.06	566	566
leadframe	inorganic material	phosphorus	7723-14-0	0.322	0.02		152	
	non noble metal	iron	7439-89-6	1.075	0.05		505	
wire	non noble metal	copper	7440-50-8	1073.304	50.46	50.53	504610	505267
	non noble metal	aluminium	7429-90-5	0.245	0.01	0.01	115	115
encapsulation	organic material	carbon black	1333-86-4	5.260	0.25		2473	
	inorganic material	zink oxide	1314-13-2	72.914	3.43		34280	
	plastics	epoxy resin	-	99.633	4.68		46842	
leadfinish	inorganic material	silicondioxide	60676-86-0	864.863	40.66	49.02	406613	490208
	non noble metal	tin	7440-31-5	7.067	0.33	0.33	3323	3323
solder	non noble metal	antimony	7440-36-0	0.111	0.01		52	
	noble metal	silver	7440-22-4	0.277	0.01		130	
*deviation	non noble metal	tin	7440-31-5	0.721	0.03	0.05	339	521
					Sum in total:		100.00	

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and does not use any exemption

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